FAIRCHILD SEMICONDUCTOR®

July 2009

FOD410, FOD4108, FOD4116, FOD4118
6-Pin DIP Zero-Cross Triac Drivers

Features

- 300mA on-state current
- Zero-voltage crossing
- High blocking voltage
  - 800V (FOD4108, FOD4118)
  - 600V (FOD410, FOD4116)
- High trigger sensitivity
  - 1.3mA (FOD4116, FOD4118)
  - 2mA (FOD410, FOD4108)
- High static dv/dt (10,000V/µs)
- UL, VDE, CSA approved
- Lead free assembly

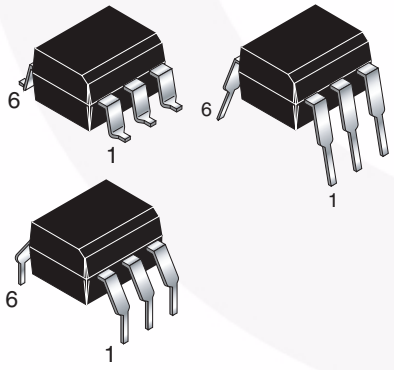
Applications

- Solid-state relays
- Industrial controls
- Lighting controls
- Static power switches
- AC motor starters

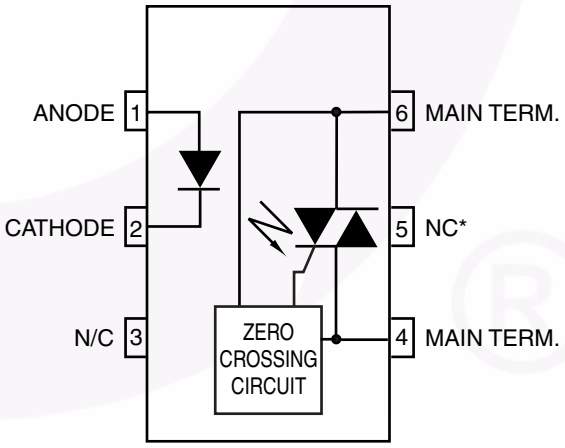
Description

The FOD410, FOD4108, FOD4116 and FOD4118 devices consist of an infrared emitting diode coupled to a hybrid triac formed with two inverse parallel SCRs which form the triac function capable of driving discrete triacs. The FOD4116 and FOD4118 utilize a high efficiency infrared emitting diode which offers an improved trigger sensitivity. These devices are housed in a standard 6-pin dual in-line (DIP) package.

Package



Schematic



*DO NOT CONNECT
(TRIAC SUBSTRATE)

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Absolute Maximum Ratings (T_A = 25°C unless otherwise noted)

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameters	Device	Value	Units
TOTAL DEVICE				
T_{STG}	Storage Temperature	All	-55 to +150	°C
T_{OPR}	Operating Temperature	All	-55 to +100	°C
T_{SOL}	Lead Solder Temperature (Wave)	All	260 for 10 sec	°C
T_J	Junction Temperature Range	All	125	°C
V_{ISO}	Isolation Test Voltage[1] (rms AC voltage, 60Hz, 1 min. duration)	All	5000	Vac(rms)
P_{DTOTAL}	Total Device Power Dissipation @ 25°C	All	500	mW
	Derate above 25°C		6.6	mW/°C
EMITTER				
I_F	Continuous Forward Current	All	30	mA
V_R	Reverse Voltage	All	6	V
P_{DE}	Total Power Dissipation 25°C Ambient	All	50	mW
	Derate above 25°C		0.71	mW/°C
DETECTOR				
V_{DRM}	Off-State Output Terminal Voltage	FOD410, FOD4116	600	V
		FOD4108, FOD4118	800	
I_{TSM}	Peak Non-Repetitive Surge Current (single cycle 60Hz sine wave)	All	3	A
I_{TM}	Peak On-State Current	All	300	mA
P_{DDET}	Total Power Dissipation @ 25°C Ambient	All	450	mW
	Derate above 25°C		5.9	mW/°C

Note:

1. Isolation voltage, V_{ISO}, is an internal device dielectric breakdown rating. For this test, Pins 1, 2 and 3 are common, and Pins 4, 5 and 6 are common. 5,000 VRMS for 1 minute duration is equivalent to 6,000 VRMS for 1 second duration.

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Electrical Characteristics (T_A = 25°C Unless otherwise specified)

Individual Component Characteristics

Symbol	Parameters	Test Conditions		Device	Min.	Typ.*	Max	Units
EMITTER								
V_F	Input Forward Voltage	I_F = 20mA		All		1.25	1.5	V
I_R	Reverse Leakage Current	V_R = 6V		All		0.0001	10	µA
DETECTOR								
$I_{D(RMS)}$	Peak Blocking Current, Either Direction	I_F = 0, T_A = 100°C(2)	V_D = 800V	FOD4108, FOD4118		3	100	µA
			V_D = 600V	FOD410, FOD4116				
$I_{R(RMS)}$	Reverse Current	T_A = 100°C	V_D = 800V	FOD4108, FOD4118		3	100	µA
			V_D = 600V	FOD410, FOD4116				
dv/dt	Critical Rate of Rise of Off-State Voltage	I_F = 0(4) (Fig. 11)			10,000			V/µs

Transfer Characteristics

Symbol	DC Characteristics	Test Conditions		Device	Min.	Typ.*	Max.	Units
I_{FT}	LED Trigger Current	Main Terminal Voltage = 5V(3)		FOD410, FOD4108		0.65	2.0	mA
				FOD4116, FOD4118		0.65	1.3	
V_{TM}	Peak On-State Voltage, Either Direction	I_{TM} = 300 mA peak, I_F = rated I_{FT}		All		2.2	3	V
I_H	Holding Current, Either Direction	V_T = 3V		All		200	500	µA
I_L	Latching Current	V_T = 2.2V		All		5		mA
t_{ON}	Turn-On Time	PF = 1.0, I_T = 300mA	V_{RM} = V_{DM} = 565 VAC	FOD4108		60		µs
			V_{RM} = V_{DM} = 424 VAC	FOD410, FOD4116, FOD4118				
t_{OFF}	Turn-Off Time		V_{RM} = V_{DM} = 565 VAC	FOD4108		52		µs
			V_{RM} = V_{DM} = 424 VAC	FOD410, FOD4116, FOD4118				
dv/dt_{crq}	Critical Rate of Rise of Voltage at Current Commutation	V_D = 0.67 V_{DRM}, $di/dt_{crq} \leq$ 15 A/ms	T_j = 25°C	All	10,000			V/µs
			T_j = 80°C		5,000			
di/dt_{cr}	Critical Rate of Rise of On-State Current			All			8	A/µs
dV(IO)/dt	Critical Rate of Rise of Coupled Input/Output Voltage	I_T = 0A, V_{RM} = V_{DM} = 424VAC		All		10,000		V/µs

*Typical values at T_A = 25°C

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Electrical Characteristics (T_A = 25°C Unless otherwise specified) (Continued)

Zero Crossing Characteristics

Symbol	DC Characteristics	Test Conditions	Min.	Typ.*	Max.	Units
V_{INH}	Inhibit Voltage (MT1-MT2 voltage above which device will not trigger)	I_F = Rated I_{FT}		8	25	V
I_{DRM2}	Leakage in Inhibited State	I_F = Rated I_{FT}, Rated V_{DRM}, off state		20	200	µA

Isolation Characteristics

Symbol	Characteristics	Test Conditions	Min.	Typ.*	Max.	Units
V_{ISO}	Input-Output Isolation Voltage	f = 60Hz, t = 1 min.(5)	5000			Vac(rms)

*Typical values at T_A = 25°C

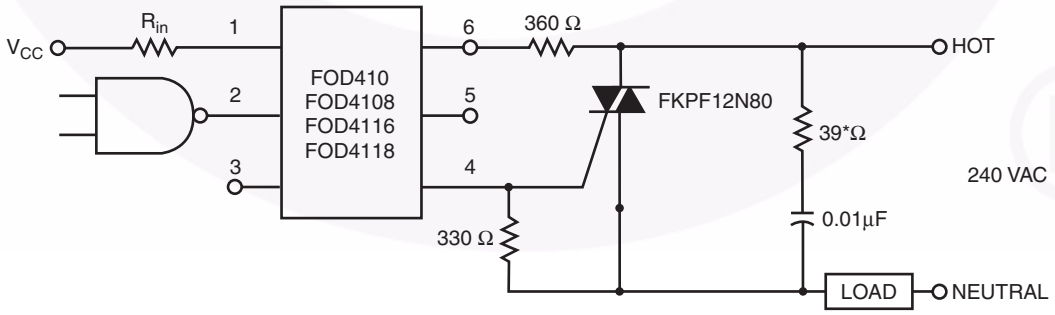
Notes:

2. Test voltage must be applied within dv/dt rating.
3. All devices are guaranteed to trigger at an I_F value less than or equal to max I_{FT}. Therefore, recommended operating I_F lies between max I_{FT} (2mA for FOD410 and FOD4108 and 1.3mA for FOD4116 and FOD4118 and the absolute max I_F (60mA).
4. This is static dv/dt. See Figure 11 for test circuit. Commutating dv/dt is a function of the load-driving thyristor(s) only.
5. Isolation voltage, V_{ISO}, is an internal device dielectric breakdown rating. For this test, Pins 1, 2 and 3 are common, and Pins 4, 5 and 6 are common.

Typical Application

Typical circuit for use when hot line switching is required. In this circuit the “hot” side of the line is switched and the load connected to the cold or neutral side. The load may be connected to either the neutral or hot line.

R_{in} is calculated so that I_F is equal to the rated I_{FT} of the part, 2mA for FOD410 and FOD4108, 1.3mA for FOD4116 and FOD4118. The 39Ω resistor and 0.01µF capacitor are for snubbing of the triac and may or may not be necessary depending upon the particular triac and load use.



* For highly inductive loads (power factor < 0.5), change this value to 360 ohms.

Figure 1. Hot-Line Switching Application Circuit

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Typical Performance Curves

Figure 2. Forward Voltage (V_F) vs. Forward Current (I_F)

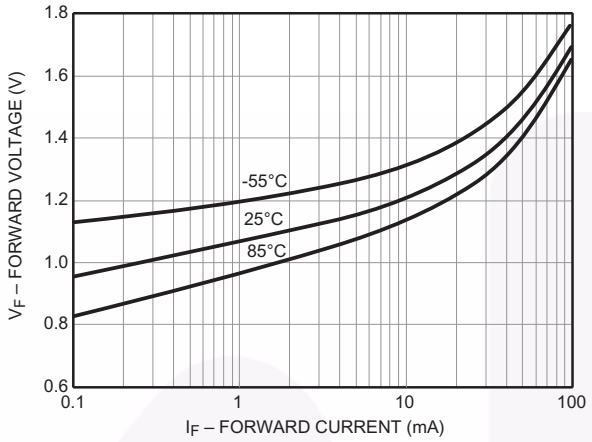


Figure 3. Normalized LED Trigger Current (I_{FT}) vs. Ambient Temperature (T_A)

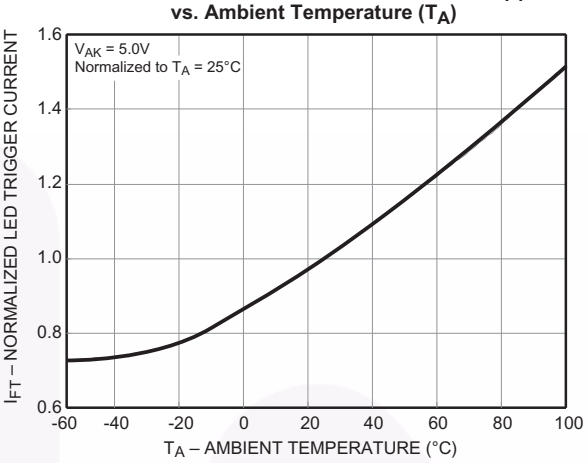


Figure 4. Peak LED Current vs. Duty Factor, Tau

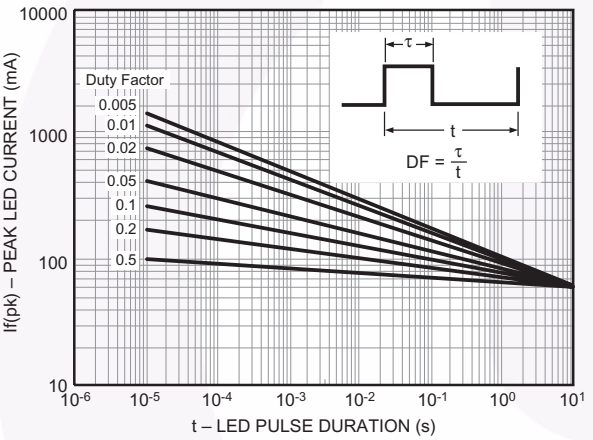


Figure 5. Trigger Delay Time

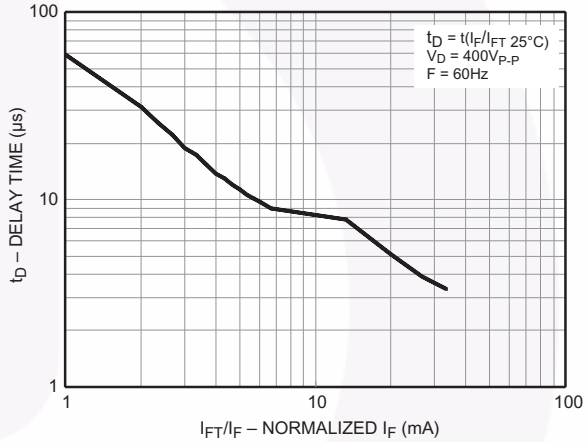


Figure 6. Pulse Trigger Current

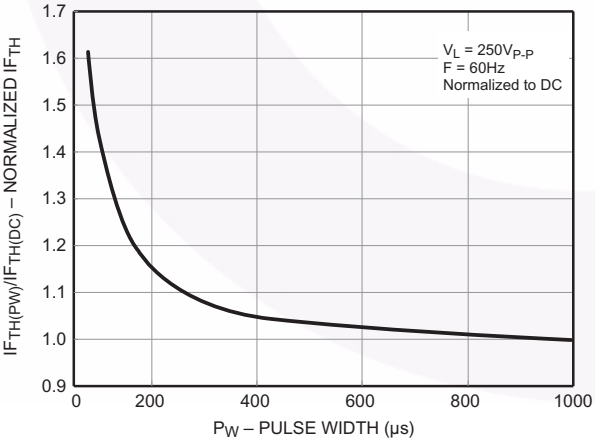
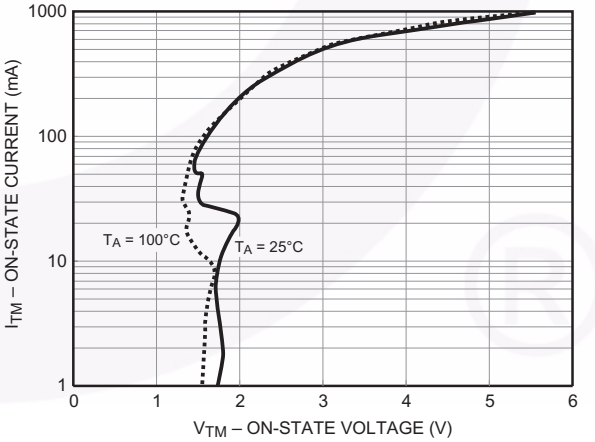


Figure 7. On-State Voltage (V_{TM}) vs. On-State Current (I_{TM})



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Typical Performance Curves (Continued)

Figure 8. Normalized Holding Current (I_H) vs. Ambient Temperature (T_A)

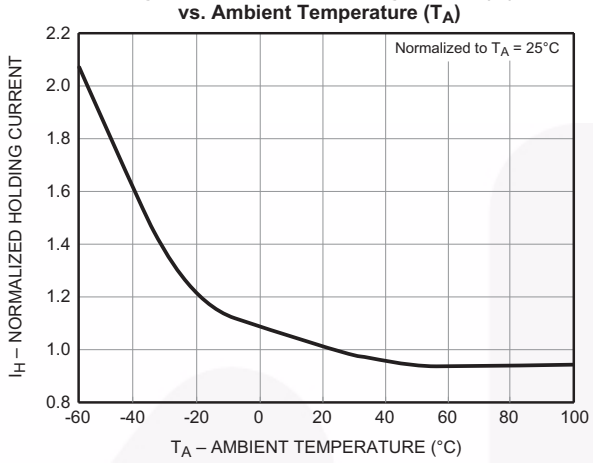


Figure 9. Normalized Off-State Current (I_{DRM}) vs. Ambient Temperature (T_A)

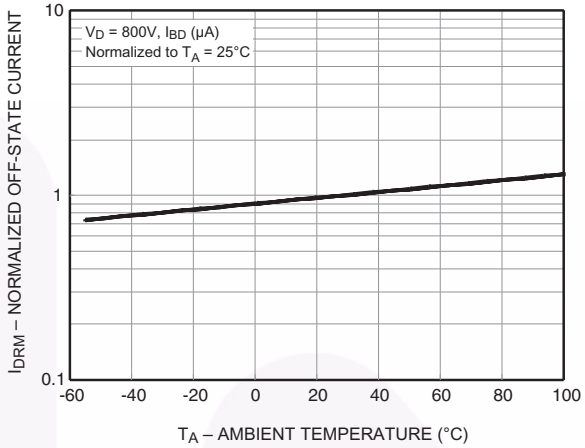


Figure 10. Normalized Inhibit Voltage (V_{INH}) vs. Ambient Temperature (T_A)

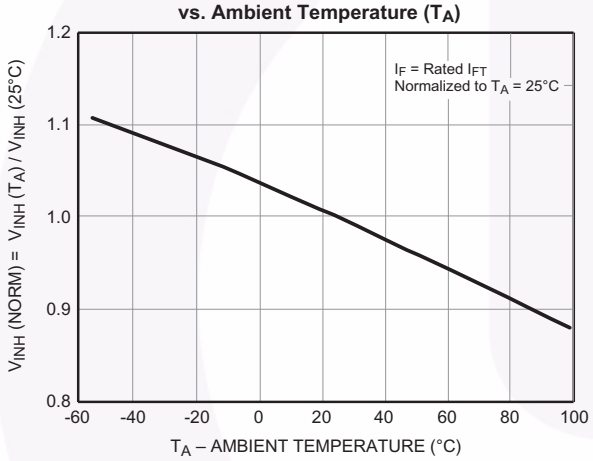


Figure 11. Normalized Leakage in Inhibit State (I_{DRM2}) vs. Ambient Temperature (T_A)

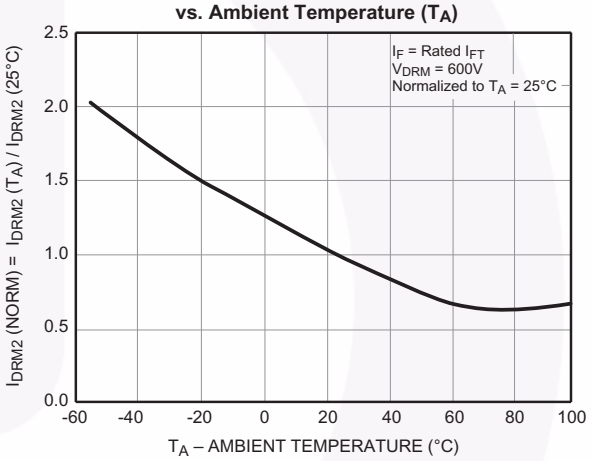
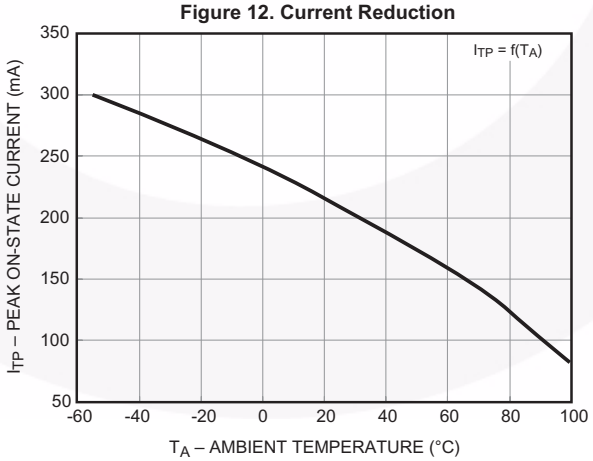
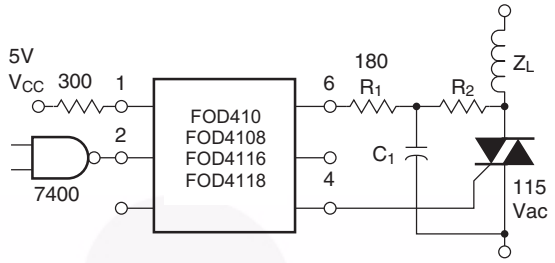


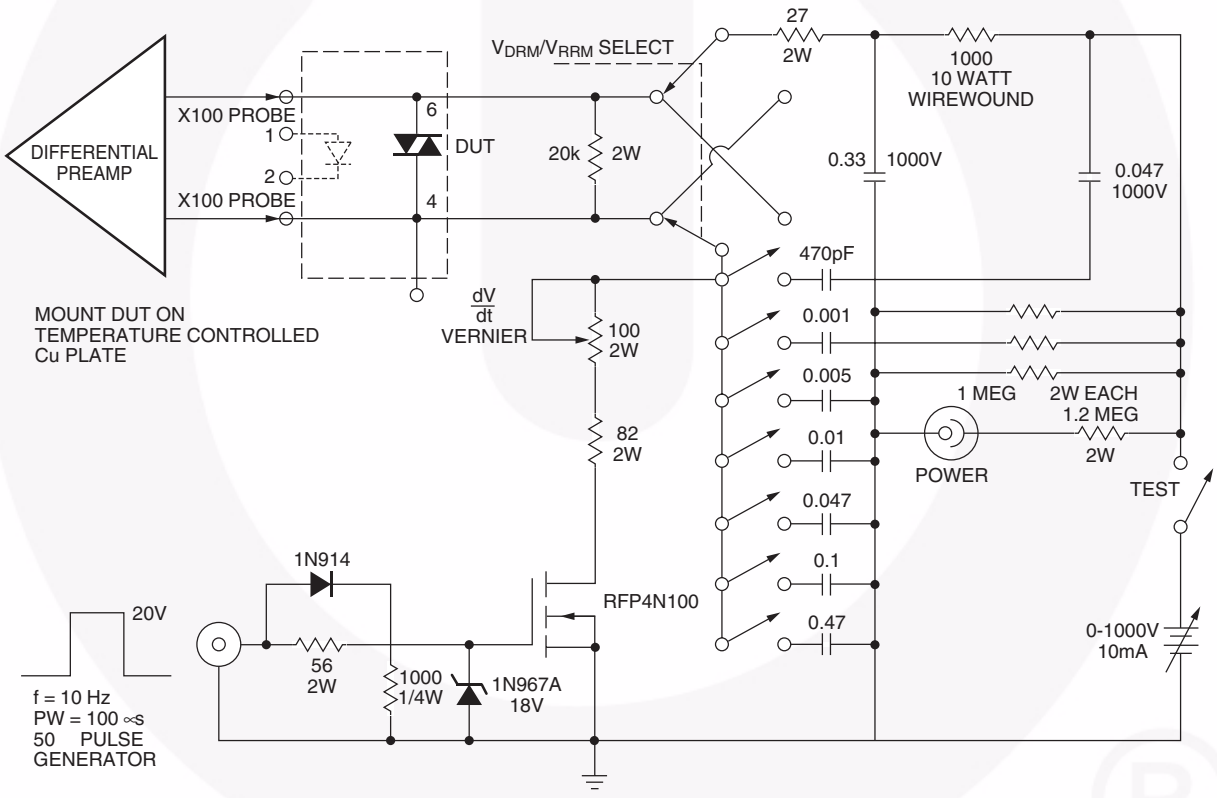
Figure 12. Current Reduction





NOTE: Circuit supplies 25mA drive to gate of triac at V_{in} = 25V and T_A < 70°C

TRIAC		
I_{GT}	R_2	C
15 mA	2400	0.1
30 mA	1200	0.2
50 mA	800	0.3



ALL COMPONENTS ARE NON-INDUCTIVE UNLESS SHOWN

Figure 11. Circuit for Static $\frac{dV}{dt}$ Measurement of Power Thyristors

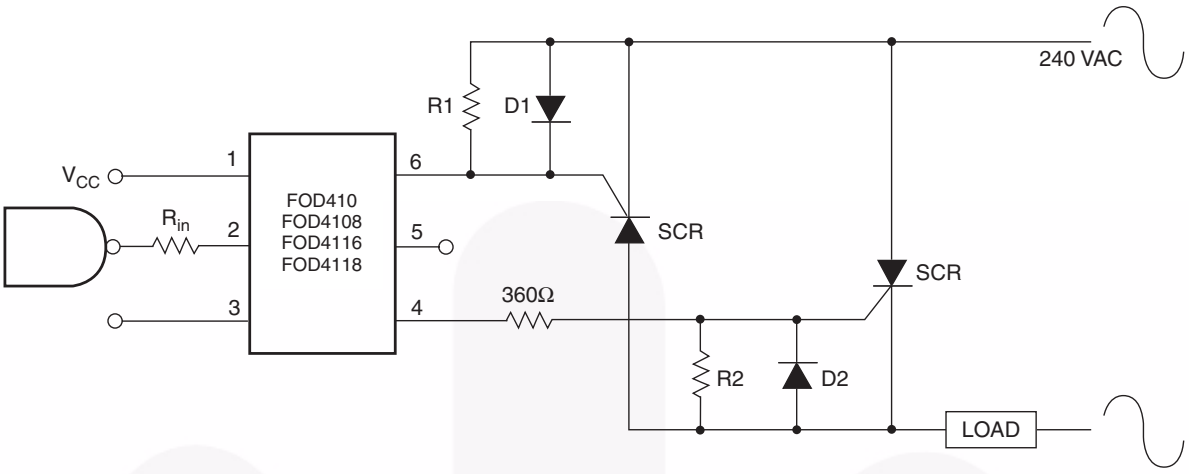


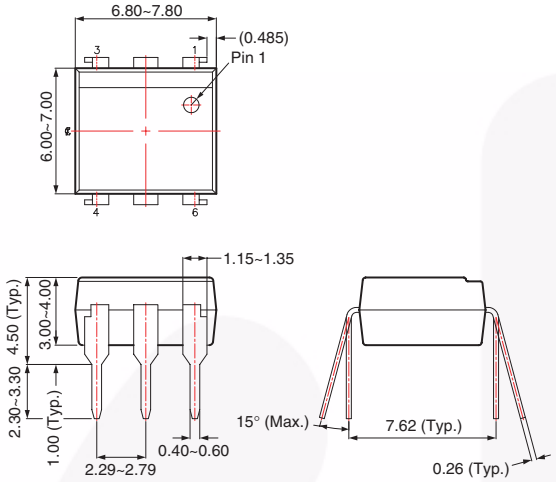
Figure 12. Inverse-Parallel SCR Driver Circuit

Suggested method of firing two, back-to-back SCR's with a Fairchild triac driver. Diodes can be 1N4001; resistors, R1 and R2, are optional 330Ω.

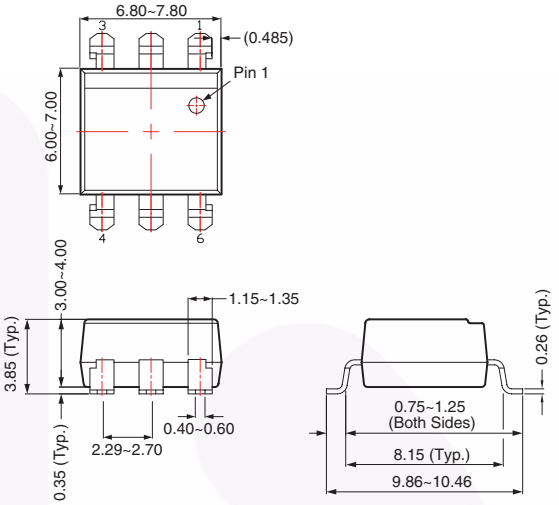
Note: This optoisolator should not be used to drive a load directly. It is intended to be a discrete triac driver device only.

Package Dimensions

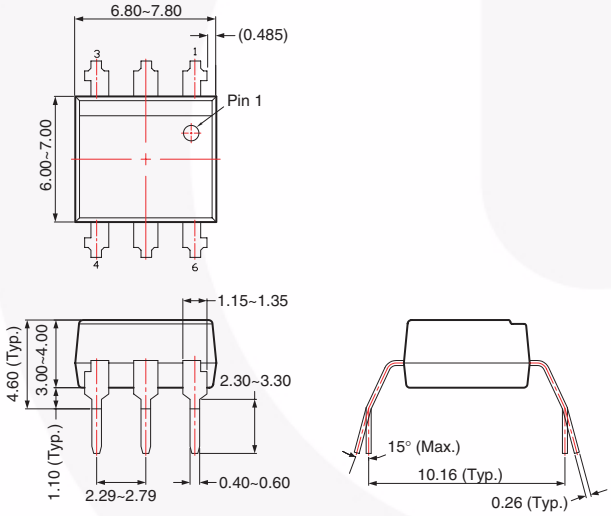
Through Hole



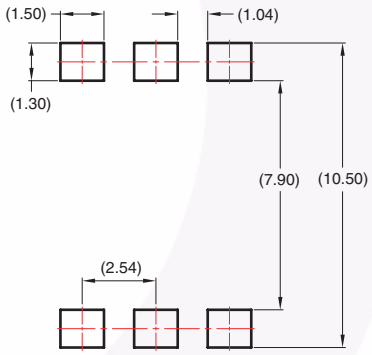
Surface Mount



0.4" Lead Spacing



Recommended Pad Layout for Surface Mount Leadforms

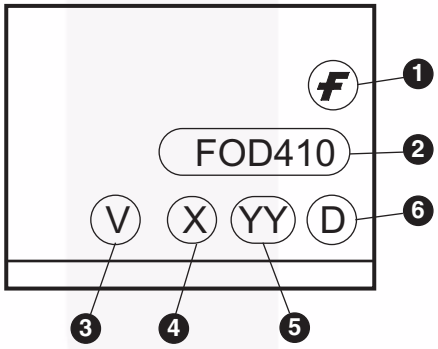


Note:
All dimensions are in millimeters.

Ordering Information

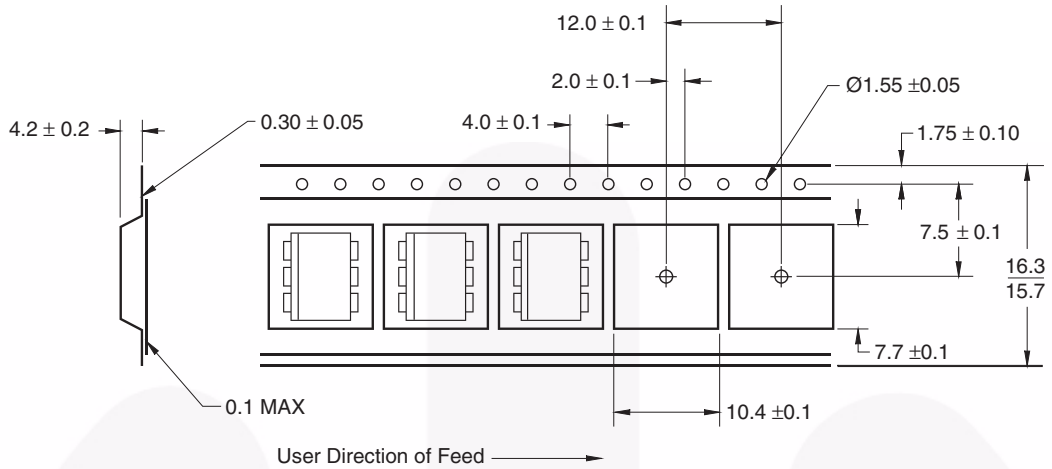
Option	Order Entry Identifier (example)	Description
None	FOD410	Standard Through Hole Device
S	FOD410S	Surface Mount Lead Bend
SD	FOD410SD	Surface Mount; Tape and reel
T	FOD410T	0.4" Lead Spacing
V	FOD410V	IEC60747-5-2 certification
TV	FOD410TV	IEC60747-5-2 certification, 0.4" Lead Spacing
SV	FOD410SV	IEC60747-5-2 certification, Surface Mount
SDV	FOD410SDV	IEC60747-5-2 certification, Surface Mount, Tape & Reel

Marking Information



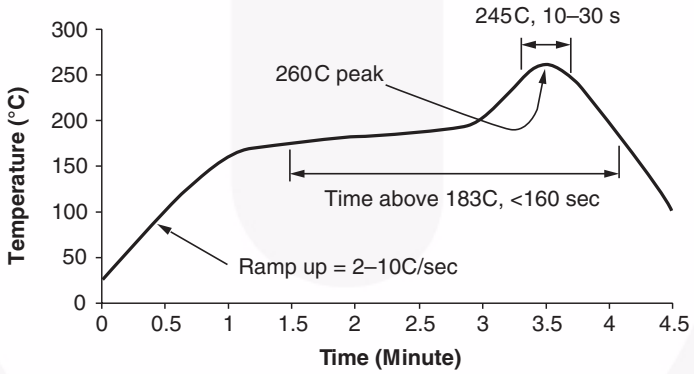
Definitions	
1	Fairchild logo
2	Device number
3	VDE mark indicates IEC60747-5-2 certified (Note: Only appears on parts ordered with VDE option – See order entry table)
4	One digit year code, e.g., ‘7’
5	Two digit work week ranging from ‘01’ to ‘53’
6	Assembly package code

Carrier Tape Specifications



Note:
All dimensions are in inches (millimeters).

Reflow Profile



- Peak reflow temperature: 260C (package surface temperature)
- Time of temperature higher than 183C for 160 seconds or less
- One time soldering reflow is recommended

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PRODUCT STATUS DEFINITIONS

Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

Rev. I40

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Данный компонент на территории Российской Федерации

Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

http://moschip.ru/get-element

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

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